

# **Description**

The BSC093N04LSG uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. Thisdevice is suitable for use as a Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = 40V I<sub>D</sub> =60 A

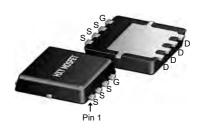
 $R_{DS(ON)} < 8.5 \text{m}\Omega @ V_{GS}=10V$ 

## **Application**

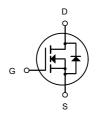
Battery protection

Load switch

Uninterruptible power supply



DFN5X6-8L



N-Channel MOSFET

**Package Marking and Ordering Information** 

Product ID	Pack	Brand	Qty(PCS)
BSC093N04LS	DFN5X6-8L	HXY MOSFET	5000

## Absolute Maximum Ratings (T<sub>C</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter	Rating	Units
V <sub>D</sub> s	Drain-Source Voltage	V	
Vgs	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	60	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	35	A
Ідм	Pulsed Drain Current <sup>2</sup>	105	А
EAS	Single Pulse Avalanche Energy³	48	mJ
las	Avalanche Current	35	А
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	39	W
Тѕтс	Storage Temperature Range -55 to 150		°C
TJ	Operating Junction Temperature Range -55 to		°C
Reja	Thermal Resistance Junction-ambient (Steady State)¹		°C/W
Rejc	R <sub>θ</sub> Jc Thermal Resistance Junction-Case <sup>1</sup>		°C/W

### N-Channel Enhancement Mode MOSFET

# Electrical Characteristics (T = 25 , unless otherwise noted)

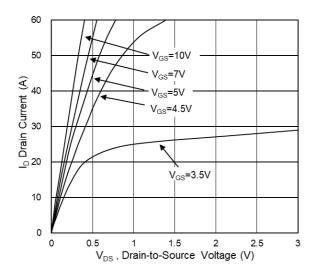
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	40			V	
Rds(on)		V <sub>GS</sub> =10V , I <sub>D</sub> =10A		7	8.5	mΩ	
	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =5A		10	15		
VGS(th)	Gate Threshold Voltage	Gate Threshold Voltage V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA		1.7	3	V	
	Drain-Source Leakage Current	V <sub>DS</sub> =32V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	ПΔ	
Ipss		V <sub>DS</sub> =32V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5		
Igss	Gate-Source Leakage Current	Gate-Source Leakage Current V <sub>GS=</sub> ±20V , V <sub>DS</sub> =0V			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =5A		27		S	
Qg	Total Gate Charge (4.5V)			20			
Qgs	Gate-Source Charge	V <sub>DS</sub> =20V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		5.8		nC	
Qgd	Gate-Drain Charge			9.5			
Td(on)	Turn-On Delay Time			15.2			
Tr	Rise Time	V <sub>DD</sub> =15V , V <sub>GS</sub> =10V		8.8			
Td(off)	Turn-Off Delay Time			74		ns	
Tf	Fall Time	ID- IA		7			
Ciss	Input Capacitance			690			
Coss	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		193		рF	
Crss	Reverse Transfer Capacitance			38			
ls	Continuous Source Current <sup>1,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			70	Α	
VsD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1	V	

#### Note:

- 1.The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leqq$  300us , duty cycle  $\leqq$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH,I<sub>AS</sub>=47A
- 4.The power dissipation is limited by 150  $^{\circ}\mathrm{C}$  junction temperature
- 5.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

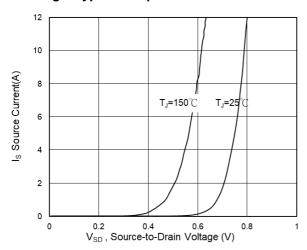


Fig.3 Source Drain Forward Characteristics

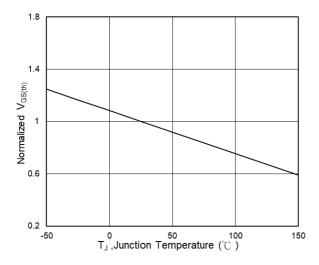


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs  $T_{\text{J}}$ 

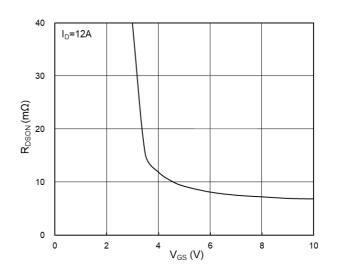


Fig.2 On-Resistance vs G-S Voltage

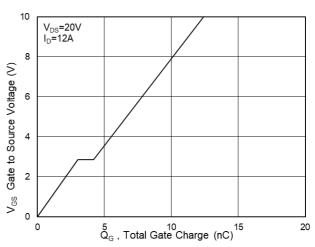


Fig.4 Gate-Charge Characteristics

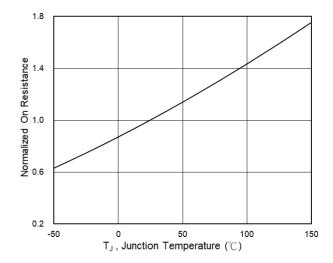
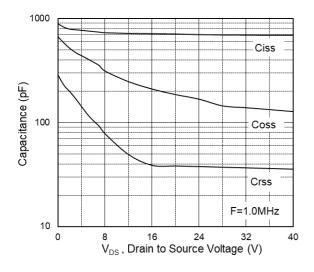


Fig.6 Normalized R<sub>DSON</sub> vs T<sub>J</sub>



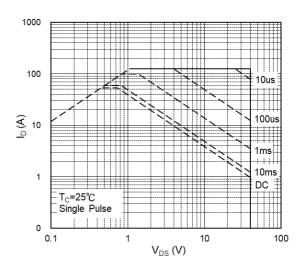
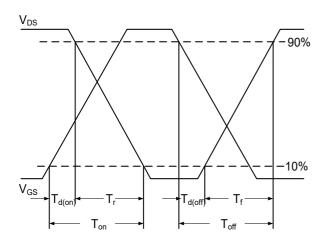
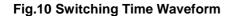


Fig.7 Capacitance Fig.8 Safe Operating Area Normalized Thermal Response (Reuc) DUTY=0.5 0.3 0.1 0.05 0.02 0.01  $D = T_{ON}/T$ SINGLE PUL  $T_J$ peak =  $T_C + P_{DM} x R_{\theta JC}$ 0.01 0.00001 0.0001 0.001 0.01 0.1 t, Pulse Width (s)

Fig.9 Normalized Maximum Transient Thermal Impedance





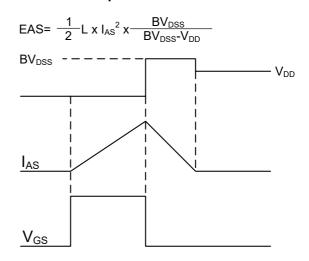
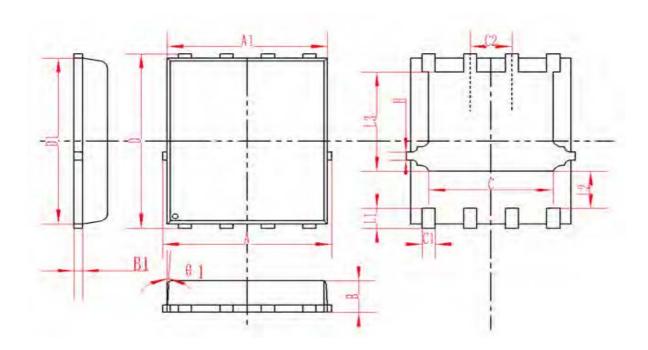


Fig.11 Unclamped Inductive Waveform

# **DFN5X6-8L Package Information**



SYMBOL	MM		INCH				
O I WIDOL	MIN	NOM	MAX	MIN	NOM	MAX	
Α	5.3	5.5	5.7	0.208	0.216	0.224	
A1	5.1	5.2	5.3	0.2	0.204	0.209	
D	5.98	6	6.02	0.235	0.236	0.237	
D1	5.85	6.05	6.25	0.23	0.238	0.246	
В	0.85	0.95	1.05	0.033	0.037	0.041	
B1		0.254REF			0.010REF		
С	3.95	4	4.05	0.156	0.157	0.159	
C1	0.35	0.4	0.45	0.014	0.016	0.018	
C2		1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°	
L1	0.63	0.64	0.65	0.025	0.025	0.026	
L2	1.2	1.3	1.4	0.047	0.051	0.055	
L3	3.415	3.42	3.425	0.134	0.135	0.135	
Н	0.24	0.25	0.26	0.009	0.010	0.010	



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